PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Wei-Sin TAN	02/10/2011
Alistair Paul CURD	02/10/2011
Valerie BERRYMAN-BOUSQUET	02/10/2011

RECEIVING PARTY DATA

Name:	SHARP KABUSHIKI KAISHA		
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City:	Osaka		
State/Country:	JAPAN		
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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13025265	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	SHRPP0148US	
NAME OF SUBMITTER:	Mark D. Saralino	

Total Attachments: 2

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PATENT REEL: 025800 FRAME: 0869

ASSIGNMENT

WHEREAS:

NAME(S) AND ADDRESS(ES) OF INVENTOR(S) Wei-Sin TAN 71, The Heyes, Gloucester Green Oxford OX1 2BU United Kingdom

Alistair Paul CURD 94 Oakridge Road

High Wycombe HP11 2PL United Kingdom

Valerie BERRYMAN-BOUSQUET 5 Marshall Crescent, Middle Barton Chipping Norton OX7 7HA United Kingdom

(hereinafter referred to as ASSIGNOR), have invented a certain invention entitled:

TITLE OF

LIGHT EMITTING DIODE WITH NANOSTRUCTURES AND METHOD OF MAKING THE SAME for which application for Letters Patent of the United States has been:

PARTICULARS OF

X] XX	executed of filed under	concurrently herev U.S. Application	vith, No. 13/0	25, on 11	FEB	2011 or	
i		Express Mail Lab		***************************************	on	***************************************	

hereby sell(s) and assign(s) the entire worldwide right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries to:

NAME, STATE OF INCORPORATION AND ADDRESS OF ASSIGNEE SHARP KABUSHIKI KAISHA 22-22, Nagaike-cho, Abeno-ku, Osaka-shi Osaka 545-8522 Japan

Including:

any and all related patent application(s) in the United States or a country foreign thereto, including continuations, continuations-in-part, divisionals, conversions, renewals, substitutes, reissues, reexaminations, extensions, non-provisional applications, convention, International (e.g., Patent Cooperation Treaty (PCT)) and other applications based in whole or in part upon said invention(s) or upon said application(s);

any and all Letters Patent, renewals, reissues, reexamination certificates and extensions of Letters Patent granted for said invention(s) or upon said application(s); and

every priority right that is or may be predicated upon or arise from said invention(s), said application(s) and said Letters Patent.

I/We additionally authorize the Assignee to file patent applications in my/our name for Letters Patent in any country (by international convention, treaty or otherwise), to be held and enjoyed by the Assignee, its successors and assigns, to the full end of the term or terms for which Letters Patent respectively may be granted, reissued, reexamined or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this Assignment and transfer not been made.

I/We also appoint the Assignee as my/our common representative to represent me/us before all the competent International Authorities in connection with any and all international applications.

I/We hereby authorize the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments to issue or transfer all said Letters Patent to the Assignee in accordance herewith.

I/We hereby covenant that I/we have the full right to convey the entire interests herein assigned, and

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that I/we have not executed and will not execute any agreement in conflict herewith and that such assigned rights are not encumbered by any grant, license or other right previously given. I/We agree that each time a request is made, and without undue delay, I/we will execute and deliver all such papers as may be necessary or desirable to perfect the title in and to the invention(s), said application(s) and said Letters Patent, to the Assignee, its successors or assigns.

I/We agree, without undue delay, to undertake all reasonable acts to assure that said invention(s), patent application(s) and Letters Patent shall be held and enjoyed by the Assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly: to execute and deliver to the Assignee all lawful documents including petitions, specifications, oaths, declarations, powers of attorney, assignments, invention disclaimers and lawful affidavits in form and substance which may be requested by the Assignee; to furnish the Assignee with all facts relating to said invention(s) or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said invention(s); and to testify in any proceedings relating to said invention(s), patent application(s) and Letters Patent.

I/We hereby sell, assign and transfer unto the Assignee the authority to revoke power(s) of attorney executed by me/us in connection with this application and to appoint a new power of attorney in place thereof.

I authorize the patent attorney of record and/or having power of attorney in the U.S. patent application identified above to insert the serial number and filing date information for the patent application in the appropriate spaces in this assignment document when that information becomes available.

FULL NAME(S) OF INVENTORS(S)

Date	10/02/2011	Lucllan
		Wei-Sin TAN
Date	10/02/2011	Alistair Paul CURD
Date	10/02/2011	Valerie BERRYMAN-BOLISOLIET